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Team Nexperia



IP4284CZ10-TBR; IP4284CZ10-TT

ESD protection for ultra high-speed interfaces

Rev. 3 — 19 May 2011

Product data sheet

1. Product profile

1.1 General description

The devices are designed to protect high-speed interfaces such as High-Definition Multimedia Interface (HDMI), DisplayPort, SuperSpeed USB, external Serial Advanced Technology Attachment (eSATA) and Low Voltage Differential Signaling (LVDS) interfaces against ElectroStatic Discharge (ESD).

The devices include high-level ESD protection diodes for ultra high-speed signal lines and are available in two package variants: XSON10 and TSSOP10.

All signal lines are protected by a special diode configuration offering ultra low line capacitance of only 0.5 pF. These diodes provide protection to downstream components from ESD voltages up to ± 8 kV contact according to IEC 61000-4-2, level 4.

1.2 Features and benefits

- Pb-free, Restriction of Hazardous Substances (RoHS) compliant and free of halogen and antimony (Dark Green compliant)
- System ESD protection for USB 2.0 and USB SuperSpeed 3.0, HDMI 1.3 and HDMI 1.4, DisplayPort, eSATA and LVDS
- All signal lines with integrated rail-to-rail clamping diodes for downstream ESD protection of ±8 kV according to IEC 61000-4-2, level 4
- Matched 0.5 mm trace spacing
- Signal lines with ≤ 0.05 pF matching capacitance between signal pairs
- Line capacitance of only 0.5 pF for each channel
- 4-channel, XSON10 or TSSOP10 Pb-free package
- Design-friendly 'pass-thru' signal routing

1.3 Applications

The devices are designed for high-speed receiver and transmitter port protection:

- TVs, monitors
- DVD recorders and players
- Notebooks, mother boards, graphic cards and ports
- Set-top boxes and game consoles



ESD protection for ultra high-speed interfaces

2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
IP428	B4CZ10-TBR	R (SOT1176-1)		
1	CH1	channel 1 ESD protection		
2	CH2	channel 2 ESD protection		
3	GND	ground		
4	CH3	channel 3 ESD protection		
5	CH4	channel 4 ESD protection	Transparent top view	本 本 本 本
6	n.c.	not connected	XSON10	
7	n.c.	not connected		3, 8 _{018aaa001}
8	GND	ground		
9	n.c.	not connected		
10	n.c.	not connected		
IP428	34CZ10-TT (SOT552-1)		
1	CH1	channel 1 ESD protection		
2	CH2	channel 2 ESD protection		
3	GND	ground		
4	CH3	channel 3 ESD protection		
5	CH4	channel 4 ESD protection		本本 本本
6	n.c.	not connected		
7	n.c.	not connected		3, 8 018aaa001
8	GND	ground		
9	n.c.	not connected	1	
10	n.c.	not connected	TSSOP10	

3. Ordering information

Table 2. Ordering information					
Type number	Package				
	Name	Description	Version		
IP4284CZ10-TBR	XSON10	plastic extremely thin small outline package; no leads; 10 terminals; body $1 \times 2.5 \times 0.5$ mm	SOT1176-1		
IP4284CZ10-TT	TSSOP10	plastic thin shrink small outline package; 10 leads; body width 3 mm	SOT552-1		

4. Marking

Table 3. Marking codes	
Type number	Marking code
IP4284CZ10-TBR	84
IP4284CZ10-TT	4284

IP4284CZ10-TBR_TT
Product data sheet

ESD protection for ultra high-speed interfaces

5. Limiting values

Table 4. In accorda	Limiting values nce with the Absolute Maxim	oum Rating System (IEC 60)134).			
Symbol	Parameter	Conditions	Min	Max	Unit	
VI	input voltage		-0.5	+5.5	V	
V _{ESD}	electrostatic discharge voltage	IEC 61000-4-2, level 4 [1]				
		contact discharge	-	±8	kV	
		air discharge	-	±15	kV	
T _{amb}	ambient temperature		-40	+85	°C	
T _{stg}	storage temperature		-55	+125	°C	

[1] All pins to ground.

6. Characteristics

Table 5. Characteristics T 25 % unlose otherwise operities

 $T_{amb} = 25 \ ^{\circ}C$ unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V _{BRzd}	Zener diode breakdown voltage	$I_{test} = 1 \text{ mA}$		6	-	9	V
I _{LRzd}	Zener diode reverse leakage current	per TMDS channel; $V_I = 3.0 V$		-	-	1	μA
V _F	forward voltage			-	0.7	-	V
$C_{\text{ch}(\text{TMDS})}$	TMDS channel capacitance	f = 1 MHz; V _{bias} = 2.5 V	[1]	0.4	0.5	0.7	pF
$\Delta C_{\text{ch(TMDS)}}$	TMDS channel capacitance difference	f = 1 MHz; V _{bias} = 2.5 V	[1]	-	0.05	-	pF
$C_{ch(mutual)}$	mutual channel capacitance	f = 1 MHz; V _{bias} = 2.5 V	<u>[1][2]</u>	-	0.07	-	pF
R _{dyn}	dynamic resistance	I = 1 A	[3]				
		positive transient		-	1	-	Ω
		negative transient		-	1	-	Ω
V _{CL(ch)trt(pos)}	positive transient channel clamping voltage	V _{ESD} = 8 kV	[4]	-	8	-	V

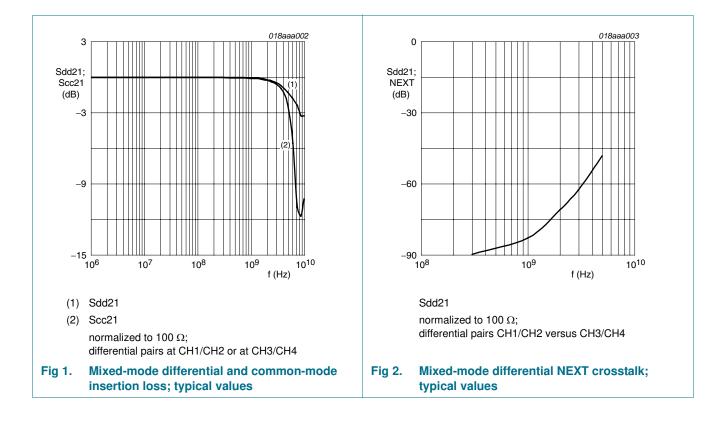
[1] This parameter is guaranteed by design.

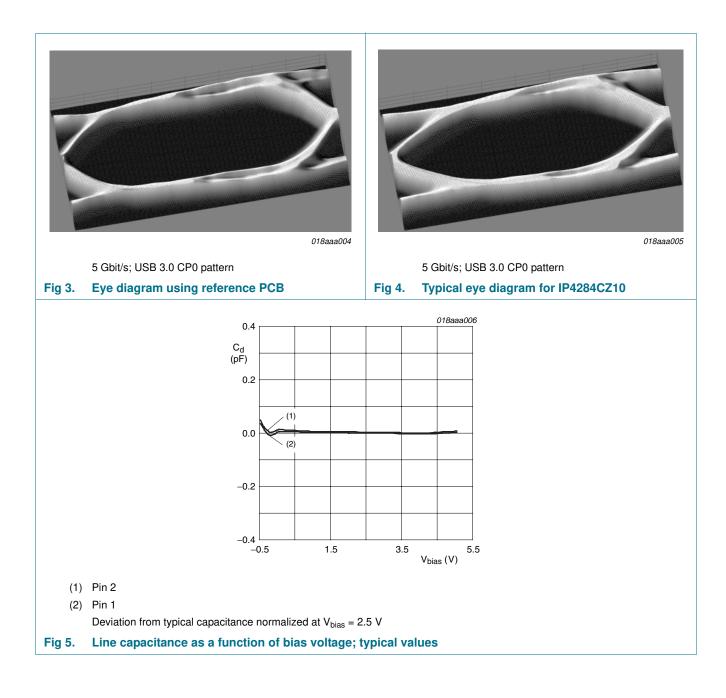
[2] Between signal pin and pin n.c.

[3] According to IEC 61000-4-5 and IEC 61000-4-9.

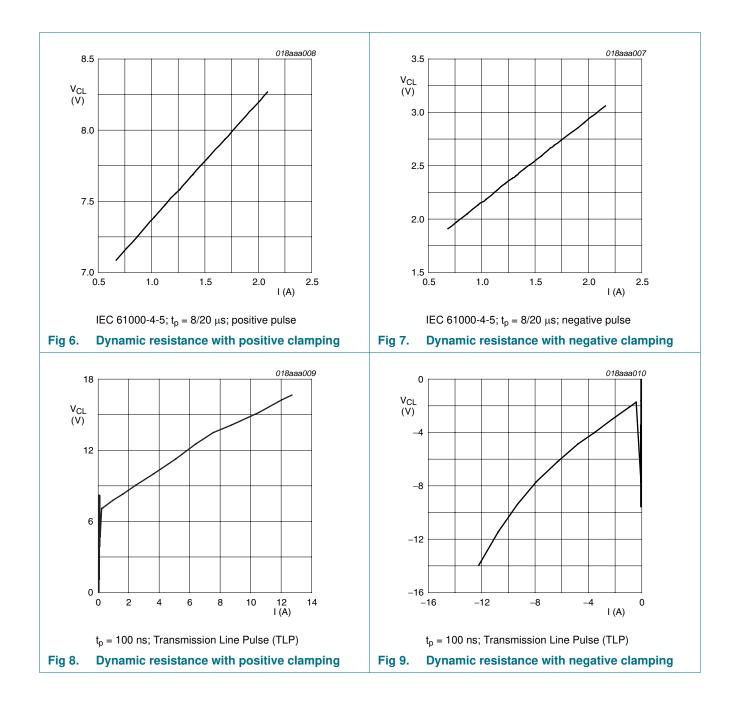
[4] Human Body Model (HBM) according to JESD22-A-J114D.

IP4284CZ10-TBR/TT





IP4284CZ10-TBR/TT



ESD protection for ultra high-speed interfaces

7. Application information

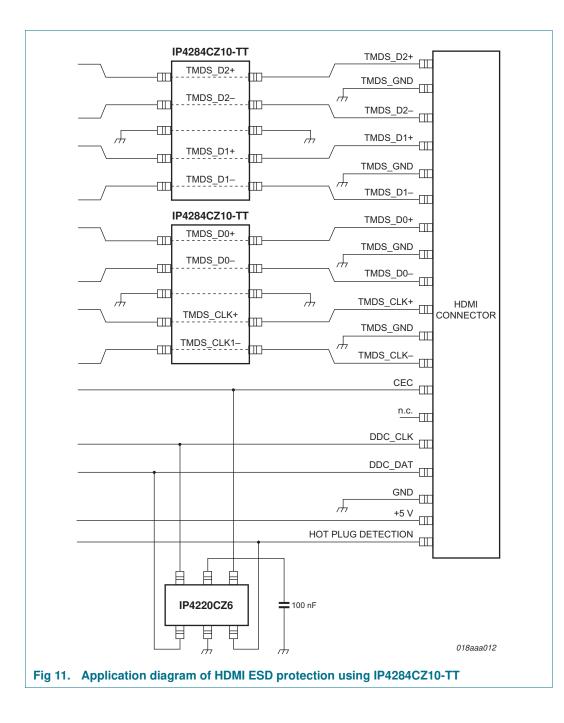
The devices are designed to provide high-level ESD protection for high-speed serial data buses such as HDMI, DisplayPort, eSATA and LVDS data lines.

When designing the Printed-Circuit Board (PCB), careful consideration should be given to basic high-speed routing guidelines, impedance matching, and signal coupling.

Basic application diagrams for the ESD protection of an HDMI interface are shown in Figure 10 and Figure 11.

		IP4284CZ10-	TBR			TMDS_D2+		
		, 		TMDS_CH2+	/	TMDS_GND		
	/	, 	4	TMDS_CH2-	$\sqrt{\frac{1}{1}}$	TMDS_D2-		
	/ 			GND	<u> </u>	TMDS_D1+		
				TMDS_CH1+	/			
	/			TMDS_CH1-	, <i>.</i>	TMDS_GND		
	/	<u>'</u>			\	TMDS_D1-		
		IP4284CZ10-		TMDS_CH2+		TMDS_D0+		
		'		 TMDS_CH2-	, 	TMDS_GND		
		-	4		$^{\prime \prime $	TMDS_D0-		
	/	- 8	3			TMDS_CLK+	HDMI	
	\			TMDS_CH1+	/	TMDS_GND	CONNECTOR	
	/	, '		TMDS_CH1-	$^{\prime \prime $	TMDS_CLK-		
						CEC		
						n.c.		
						DDC_CLK		
						DDC_DAT		
						GND		
					Æ	+5 V		
			•	НОТ	r PLUC	G DETECTION		
		IP4221CZ6	3	100 nF			018aaa115	
Fig 10. A	pplication diag	ram of HDMI	ESD	protection u	sing	IP4284CZ1	0-TBR	

IP4284CZ10-TBR_TT



IP4284CZ10-TBR/TT

ESD protection for ultra high-speed interfaces

Package outline 8.

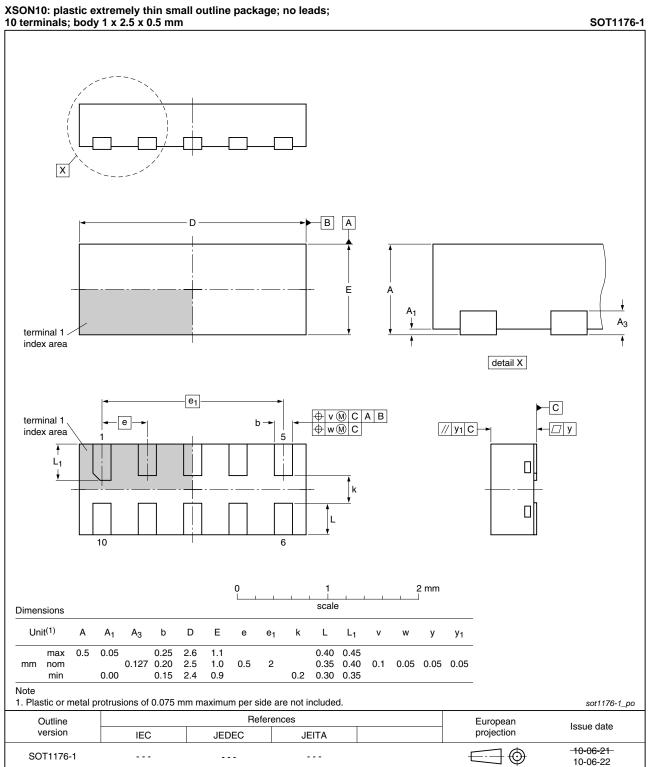


Fig 12. Package outline SOT1176-1 (XSON10)

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ESD protection for ultra high-speed interfaces

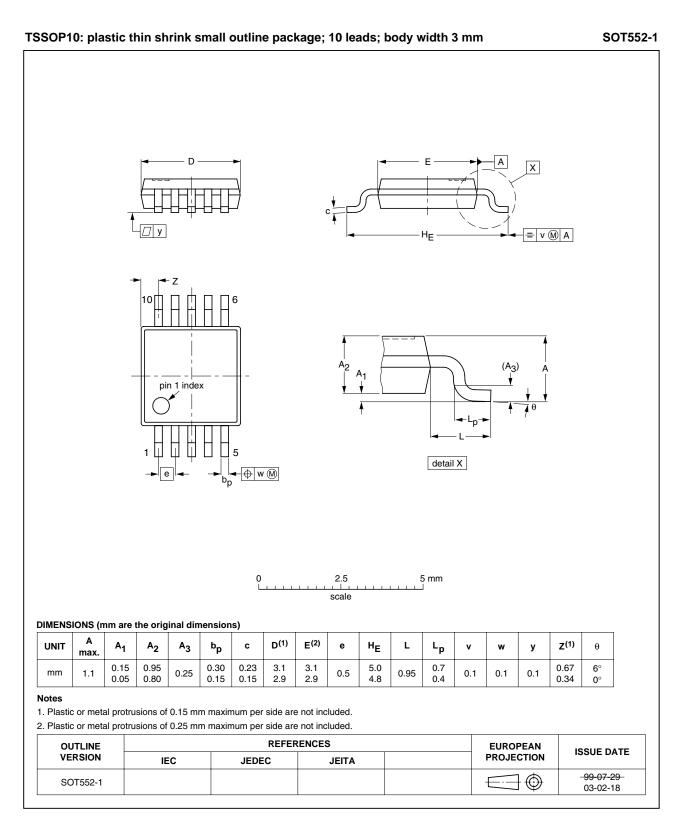


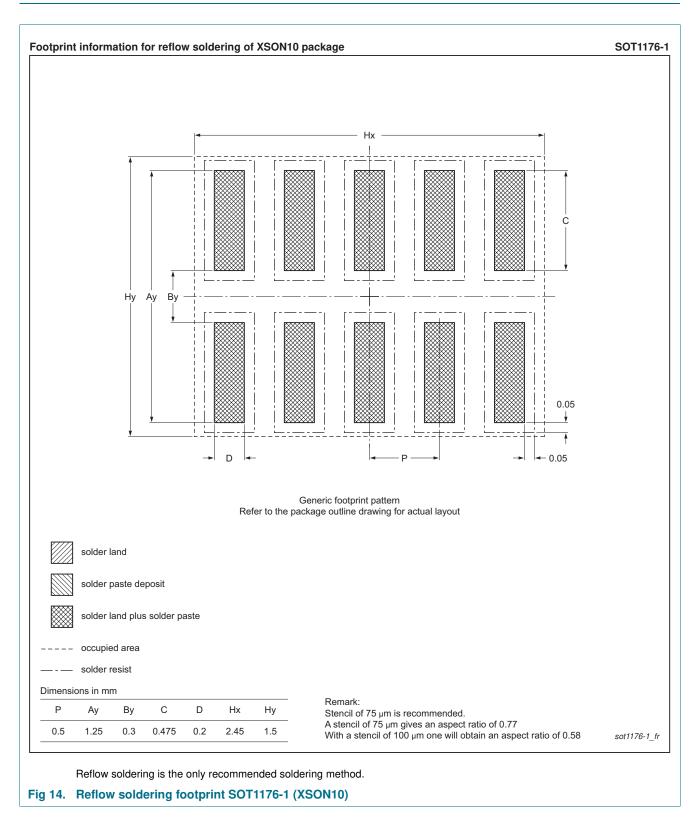
Fig 13. Package outline SOT552-1 (TSSOP10)

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ESD protection for ultra high-speed interfaces

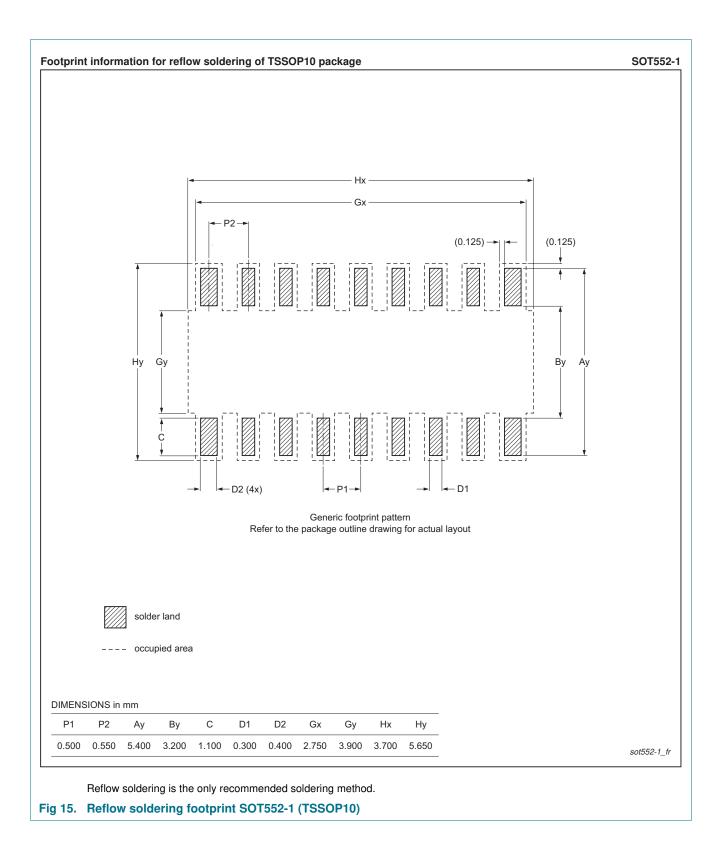
9. Soldering



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ESD protection for ultra high-speed interfaces

10. Abbreviations

Table 6.	Abbreviations
Acronym	Description
DVD	Digital Versatile Disc
eSATA	external Serial Advanced Technology Attachment
ESD	ElectroStatic Discharge
HBM	Human Body Model
HDMI	High-Definition Multimedia Interface
LVDS	Low Voltage Differential Signaling
NEXT	Near End Crosstalk
RoHS	Restriction of Hazardous Substances
TLP	Transmission Line Pulse
TMDS	Transition Minimized Differential Signaling
UTLP	Ultra Thin Leadless Package



ESD protection for ultra high-speed interfaces

11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes	
IP4284CZ10-TBR_TT v.3	20110519	Product data sheet	-	IP4284CZ10-TB_TT v.2	
Modifications:	 Deleted type 	e number IP4284CZ10-TB.			
	Added type number IP4284CZ10-TBR.				
	 Section 4 "M 	larking": added.			
	Table 4 "Lim	iting values": updated V _{ESD} v	/alues.		
	 Section 9 "S 	oldering": added.			
	 Section 12 " 	Legal information": updated.			
IP4284CZ10-TB_TT v.2	20100401	Product data sheet	-	IP4284CZ10-TB_TT v.1	
IP4284CZ10-TB TT v.1	20100304	Preliminary data sheet	-	-	

ESD protection for ultra high-speed interfaces

12. Legal information

12.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions"

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ESD protection for ultra high-speed interfaces

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